Features

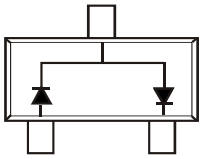
- Fast Switching Speed
- Surface-Mount Package Ideally Suited for Automated Insertion
- For General-Purpose Switching Applications
- **Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)**
- **Halogen and Antimony Free. "Green" Device (Note 3)**
- **The BAV99Q is suitable for automotive applications requiring specific change control; this part is AEC-Q101 qualified, PPAP capable, and manufactured in IATF 16949 certified facilities.**
  https://www.diodes.com/quality/product-definitions/

Mechanical Data

- Package: SOT23
- Package Material: Molded Plastic, "Green" Molding Compound UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Matte Tin Finish Annealed over Alloy 42 Leadframe (Lead Free Plating). Solderable per MIL-STD-202, Method 208 e3
- Polarity: See Diagram
- Weight: 0.008 grams (Approximate)

SOT23

Top View



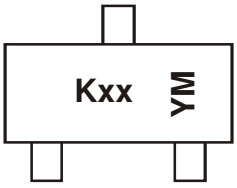
Top View
Internal Schematic

Ordering Information (Notes 4 & 5)

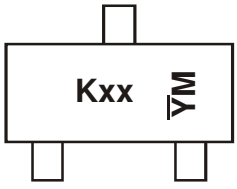
Part Number	Package	Packing	
		Qty.	Carrier
BAV99-7-F	SOT23	3000	Tape & Reel
BAV99-13-F	SOT23	10,000	Tape & Reel
BAV99Q-7-F	SOT23	3000	Tape & Reel
BAV99Q-13-F	SOT23	10,000	Tape & Reel

Notes:
1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant.
2. See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
4. For packaging details, go to our website at https://www.diodes.com/design/support/packaging/diodes-packaging/.
5. Product manufactured with Date Code 9W (week 39, 2009) and newer are built with Green Molding Compound. Product manufactured prior to Date Code 9W are built with Non-Green Molding Compound and may contain Halogens or Sb_2O_3 Fire Retardants.

Marking Information



xx = JE, Product Type Marking Code
YM = Date Code Marking for Shanghai Assembly/Test Site
Y = Year (ex: K = 2023)
M = Month (ex: 5 = May)



xx = JE, Product Type Marking Code
$\overline{Y}$M = Date Code Marking for Chengdu Assembly/Test Site
$\overline{Y}$ = Year (ex: K = 2023)
M = Month (ex: 5 = May)

Date Code Key

Year	1998	-	2023	2024	2025	2026	2027	2028	2029	2030	2031	2032
Code	J	-	K	L	M	N	P	R	S	T	U	V

Month	Jan	Feb	Mar	Apr	May	Jun	Jul	Aug	Sep	Oct	Nov	Dec
Code	1	2	3	4	5	6	7	8	9	O	N	D

Maximum Ratings (@T_A = +25°C, unless otherwise specified.)

Characteristic		Symbol	Value	Unit
Non-Repetitive Peak Reverse Voltage		V_{RM}	100	V
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage		V_{RRM} V_{RWM} V_R	75	V
RMS Reverse Voltage		$V_{R(RMS)}$	53	V
Forward Continuous Current (Note 6)		I_{FM}	300	mA
Non-Repetitive Peak Forward Surge Current	@ t = 1.0μs @ t = 1.0s	I_{FSM}	2.0 1.0	A

Thermal Characteristics

Characteristic	Symbol	Value	Unit
Power Dissipation (Note 6)	P_D	350	mW
Thermal Resistance Junction to Ambient Air (Note 6)	$R_{\theta JA}$	357	°C/W
Operating and Storage Temperature Range	T_J, T_{STG}	-55 to +150	°C

Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Max	Unit	Test Condition
Reverse Breakdown Voltage (Note 7)	$V_{(BR)R}$	75	—	V	I_R = 2.5μA
Forward Voltage	V_F	—	0.715 0.855 1.0 1.25	V	I_F = 1.0mA I_F = 10mA I_F = 50mA I_F = 150mA
Reverse Current (Note 7)	I_R	—	2.5 50 30 25	μA μA μA nA	V_R = 75V V_R = 75V, T_J = +150°C V_R = 25V, T_J = +150°C V_R = 20V
Total Capacitance	C_T	—	2.0	pF	V_R = 0, f = 1.0MHz
Reverse-Recovery Time	t_{rr}	—	4.0	ns	I_F = I_R = 10mA, I_{rr} = 0.1 x I_R, R_L = 100Ω

Notes: 6. Part mounted on Polymide PC board with pad dimensions 1.13mm × 1.27mm.
7. Short duration pulse test used to minimize self-heating effect.

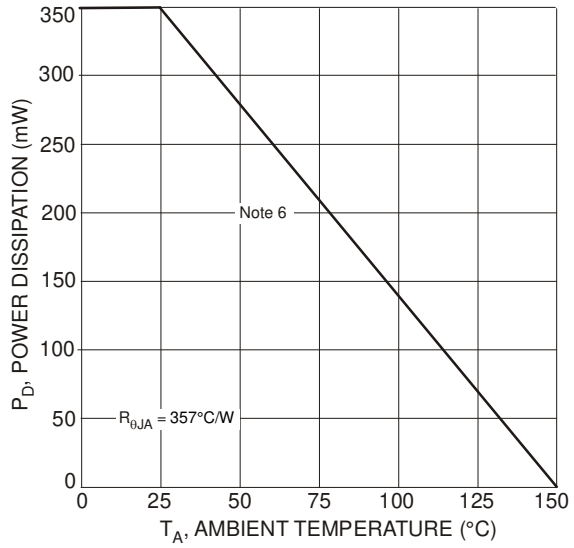


Figure 1. Power Derating Curve

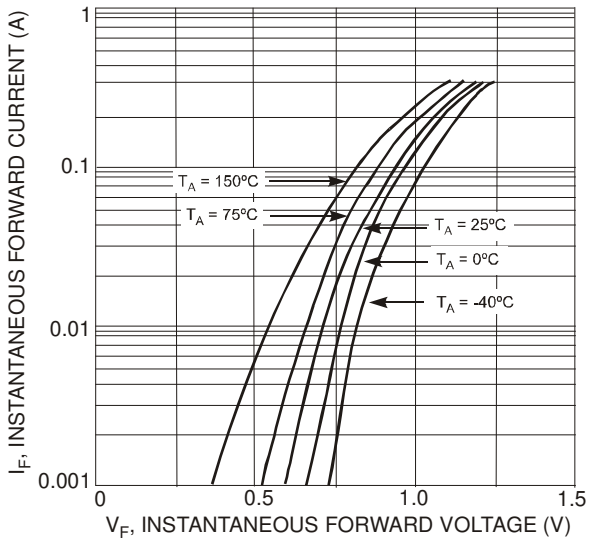


Figure 2. Forward Characteristics, Per Element

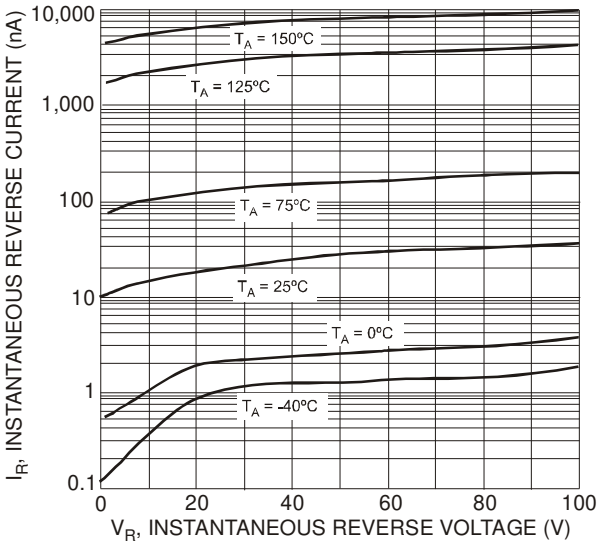


Figure 3. Typical Reverse Characteristics, Per Element

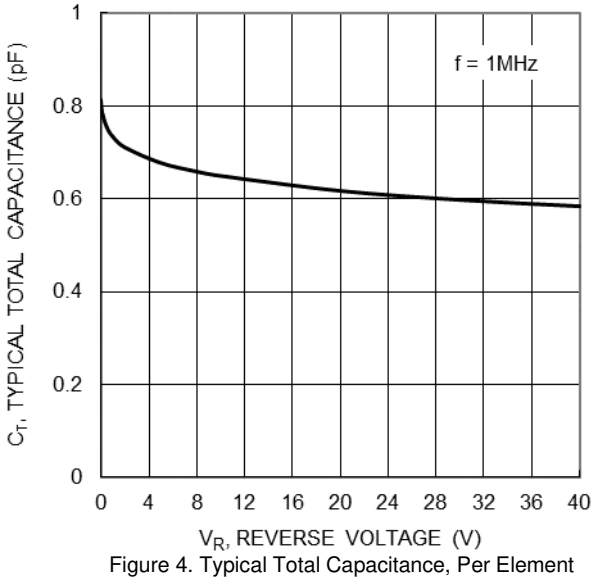


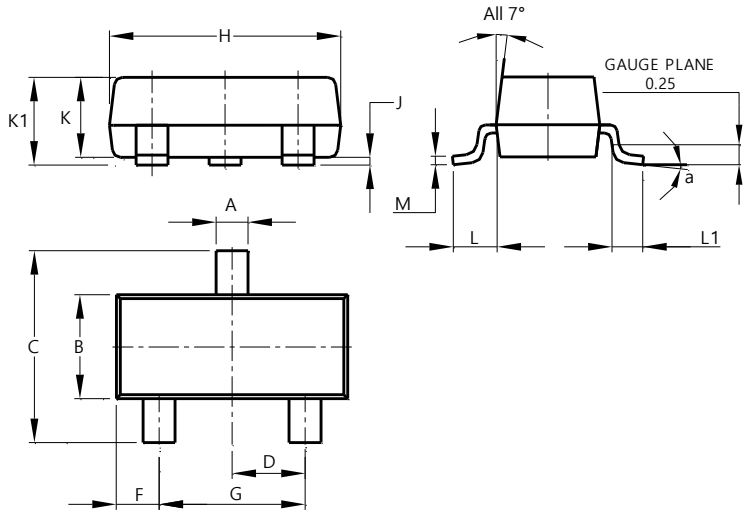
Figure 4. Typical Total Capacitance, Per Element

Note: 6. Part mounted on Polymide PC board with pad dimensions 1.13mm × 1.27mm.

Package Outline Dimensions

Please see http://www.diodes.com/package-outlines.html for the latest version.

SOT23

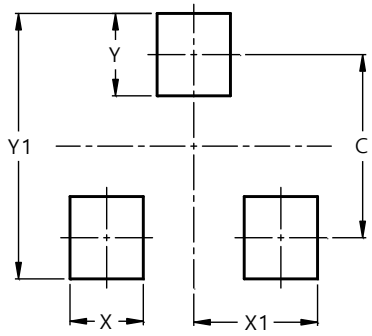


SOT23			
Dim	**Min**	**Max**	**Typ**
A	0.37	0.51	0.40
B	1.20	1.40	1.30
C	2.30	2.50	2.40
D	0.89	1.03	0.915
F	0.45	0.60	0.535
G	1.78	2.05	1.83
H	2.80	3.00	2.90
J	0.013	0.10	0.05
K	0.890	1.00	0.975
K1	0.903	1.10	1.025
L	0.45	0.61	0.55
L1	0.25	0.55	0.40
M	0.085	0.150	0.110
a	0°	8°	--
All Dimensions in mm			

Suggested Pad Layout

Please see http://www.diodes.com/package-outlines.html for the latest version.

SOT23



Dimensions	Value (in mm)
C	2.0
X	0.8
X1	1.35
Y	0.9
Y1	2.9

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